

PC817XxNiP0F Series Photocoupler

Product Specification

June 2008

PC817XxNiP0F Series

Full Specification for part numbers:

PC817XNNIP0F

PC817XINIP0F

PC817X2NIP0F

PC817X3NIP0F

PC817X4NIP0F

PC817X5NIP0F

PC817X6NIP0F

PC817X7NIP0F

PC817X8NIP0F

PC817X9NIP0F

PC817XONIP0F

SHARP

OPTO-ANALOG DEVICES DIVISION
ELECTRONIC COMPONENTS AND DEVICES GROUP
SHARP CORPORATION

SPECIFICATION

DEVICE SPECIFICATION FOR

PHOTOCOUPLER

MODEL No.

PC817

Business dealing name

	PC817XNNIPOF
	PC817X1NIP0F
	PC817X2NIP0F
	PC817X3NIP0F
	PC817X4NIP0F
	PC817X5NIP0F
	PC817X6NIP0F
	PC817X7NIP0F
	PC817X8NIP0F
	PC817X9NIP0F
	PC817X0NIP0F

Specified for _____

Enclosed please find copies of the Specifications which consists of 12 pages including cover.
This specification sheets and attached sheets shall be both side copy.
After confirmation of the contents, please be sure to send back copies of the Specifications
with approving signature on each.

CUSTOMER'S APPROVAL

DATE _____

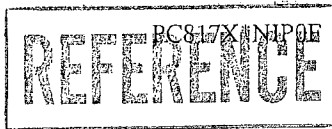
BY _____

PRESENTED

DATE June 19, 2008

BY M. Kubo

M. Kubo,
Department General Manager of
Engineering Dept., II
Opto-Analog Devices Div.
Electronic Components and Devices Group
SHARP CORPORATION



Product name : PHOTOCOUPLER

Model No. : PC817

Business dealing name

PC817XNNIP0F
PC817X1NIP0F
PC817X2NIP0F
PC817X3NIP0F
PC817X4NIP0F
PC817X5NIP0F
PC817X6NIP0F
PC817X7NIP0F
PC817X8NIP0F
PC817X9NIP0F
PC817X0NIP0F

1. These specification sheets include materials protected under copyright of Sharp Corporation ("Sharp"). Please do not reproduce or cause anyone to reproduce them without Sharp's consent.
2. When using this product, please observe the absolute maximum ratings and the instructions for use outlined in these specification sheets, as well as the precautions mentioned below. Sharp assumes no responsibility for any damage resulting from use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets, and the precautions mentioned below.

(Precautions)

- (1) This product is designed for use in the following application areas ;

(· OA equipment Audio visual equipment · Home appliances
· Telecommunication equipment (Terminal) · Measuring equipment
· Tooling machines · Computers)

If the use of the product in the above application areas is for equipment listed in paragraphs (2) or (3), please be sure to observe the precautions given in those respective paragraphs.

- (2) Appropriate measures, such as fail-safe design and redundant design considering the safety design of the overall system and equipment, should be taken to ensure reliability and safety when this product is used for equipment which demands high reliability and safety in function and precision, such as ;

(· Transportation control and safety equipment (aircraft, train, automobile etc.)
· Traffic signals · Gas leakage sensor breakers · Rescue and security equipment
· Other safety equipment)

- (3) Please do not use this product for equipment which require extremely high reliability and safety in function and precision, such as ;

(· Space equipment · Telecommunication equipment (for trunk lines)
· Nuclear power control equipment · Medical equipment)

- (4) Please contact and consult with a Sharp sales representative if there are any questions regarding interpretation of the above three paragraphs.

3. Please contact and consult with a Sharp sales representative for any questions about this product.



1. Application

This specification applies to the outline and characteristics of photocoupler Model No. PC817series(Lead-Free Type).

2. Outline Refer to the attached sheet, page 4.

3. Ratings and characteristics Refer to the attached sheet, page 5, 6.

4. Reliability Refer to the attached sheet, page 7.

5. Outgoing inspection Refer to the attached sheet, page 8.

6. Supplement

6.1 Isolation voltage shall be measured in the following method.

- (1) Short between anode and cathode on the primary side and between collector and emitter on the secondary side.
 - (2) The dielectric withstanding tester with zero-cross circuit shall be used.
 - (3) The wave form of applied voltage shall be a sine wave.
- (It is recommended that the isolation voltage be measured in insulation oil.)

6.2 Package specifications Refer to the attached sheet, page 9, 10.

6.3 Business dealing name ("O" mark indicates business dealing name of ordered product)

Ordered product	Business dealing name	Rank mark	Ic (mA)
	PC817XNNIP0F	with or without	2.5 to 30
	PC817X1NIP0F	A	4.0 to 8.0
	PC817X2NIP0F	B	6.5 to 13
	PC817X3NIP0F	C	10 to 20
	PC817X4NIP0F	D	15 to 30
	PC817X5NIP0F	A or B	4.0 to 13
	PC817X6NIP0F	B or C	6.5 to 20
	PC817X7NIP0F	C or D	10 to 30
	PC817X8NIP0F	A, B or C	4.0 to 20
	PC817X9NIP0F	B, C or D	6.5 to 30
	PC817X0NIP0F	A, B, C or D	4.0 to 30

Test conditions
$I_F=5mA$ $V_{CE}=5V$ $T_a=25^{\circ}C$

6.4 This Model is approved by UL.

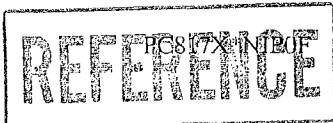
Approved Model No. : PC817

UL file No. : E64380

6.5 This product is not designed against irradiation.

This product is assembled with electrical input and output.

This product incorporates non-coherent light emitting diode.



6.6 ODS materials

This product shall not contain the following materials.

Also, the following materials shall not be used in the production process for this product.

Materials for ODS : CFCs, Halon, Carbon tetrachloride, 1,1,1-Trichloroethane (Methyl chloroform)

6.7 Specified brominated flame retardants

Specified brominated flame retardants (PBB and PBDE) are not used in this device at all

6.8 Compliance with each regulation

(1) The RoHS directive (2002/95/EC)

This product complies with the RoHS directive (2002/95/EC).

Object substances: mercury, lead, cadmium, hexavalent chromium, polybrominated biphenyls (PBB)
and polybrominated diphenyl ethers (PBDE)

(2) Content of six substances specified in Management Methods for Control of Pollution Caused by Electronic Information Products Regulation (Chinese : 电子信息产品污染控制管理办法).

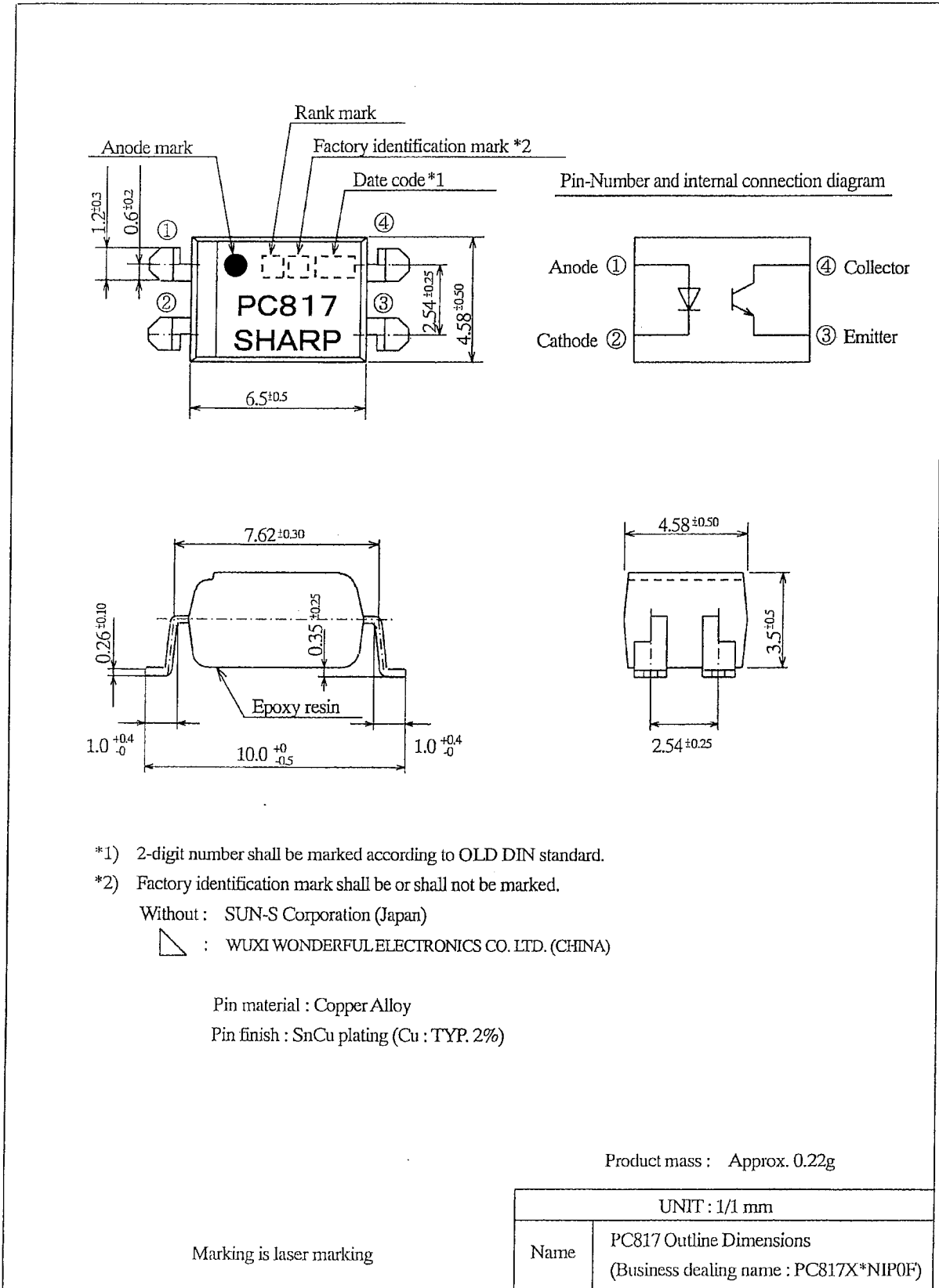
Category	Toxic and hazardous substances					
	Lead (Pb)	Mercury (Hg)	Cadmium (Cd)	Hexavalent chromium (Cr ⁶⁺)	Polybrominated biphenyls (PBB)	Polybrominated diphenyl ethers (PBDE)
Photocopier	✓	✓	✓	✓	✓	✓

✓ : indicates that the content of the toxic and hazardous substance in all the homogeneous materials of the part is below the concentration limit requirement as described in SJ/T 11363-2006 standard .

7. Notes

Precautions for photocopiers : Attachment-1

2. Outline



3. Ratings and characteristics

3.1 Absolute maximum ratings

Ta=25°C

Parameter		Symbol	Rating	Unit
Input	*1 Forward current	I_F	50	mA
	*2 Peak forward current	I_{FM}	1	A
	Reverse voltage	V_R	6	V
	*1 Power dissipation	P	70	mW
Output	Collector-emitter voltage	V_{CEO}	80	V
	Emitter-collector voltage	V_{ECO}	6	V
	Collector current	I_c	50	mA
	*1 Collector power dissipation	P_c	150	mW
*1 Total power dissipation	P_{tot}	200	mW	
Operating temperature		T_{opr}	-30 to +100	°C
Storage temperature		T_{slg}	-55 to +125	°C
*3 Isolation voltage	$V_{iso(rms)}$	5	kV	
*4 Soldering temperature	T_{sol}	270	°C	

*1 The derating factors of absolute maximum ratings due to ambient temperature are shown in Fig. 1 to 4.

*2 Pulse width $\leq 100\mu s$, Duty ratio : 0.001 (Refer to Fig. 5)

*3 AC for 1 min, 40 to 60%RH

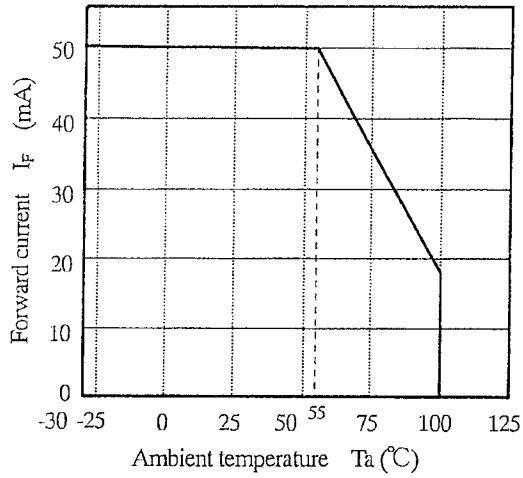
*4 For 10 s

3.2 Electro-optical characteristics

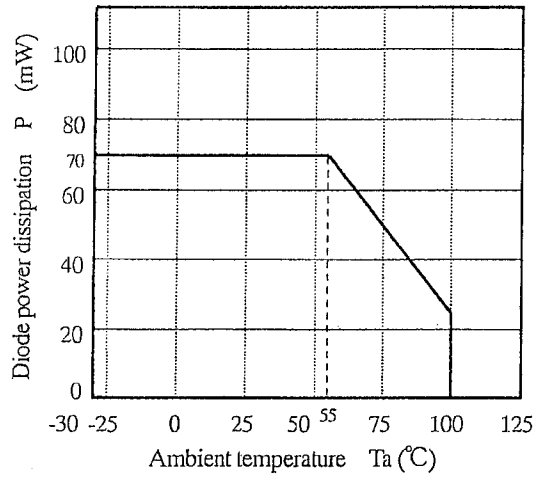
Ta=25°C

Parameter		Symbol	Condition	MIN.	TYP.	MAX.	Unit
Input	Forward voltage	V_F	$I_F=20mA$	-	1.2	1.4	V
	Peak forward voltage	V_{FM}	$I_{FM}=0.5A$	-	-	3.0	V
	Reverse current	I_R	$V_R=4V$	-	-	10	μA
	Terminal capacitance	C_t	$V=0, f=1kHz$	-	30	250	pF
Output	Dark current	I_{CEO}	$V_{CE}=50V, I_F=0$	-	-	100	nA
	Collector-emitter breakdown voltage	BV_{CEO}	$I_c=0.1mA, I_F=0$	80	-	-	V
	Emitter-collector breakdown voltage	BV_{ECO}	$I_E=10\mu A, I_F=0$	6	-	-	V
Transfer characteristics	Collector current	I_c	$I_F=5mA, V_{CE}=5V$	2.5	-	30	mA
	Collector-emitter saturation voltage	$V_{CE(sat)}$	$I_F=20mA, I_c=1mA$	-	0.1	0.2	V
	Isolation resistance	R_{ISO}	DC500V 40 to 60%RH	5×10^{10}	10^{11}	-	Ω
	Floating capacitance	C_f	$V=0, f=1MHz$	-	0.6	1.0	pF
	Cut-off frequency	f_c	$V_{CE}=5V, I_c=2mA$ $R_L=100\Omega, -3dB$	-	80	-	kHz
	Rise time	t_r	$V_{CE}=2V, I_c=2mA$	-	4	18	μs
	Fall time	t_f	$R_L=100\Omega$	-	3	18	μs

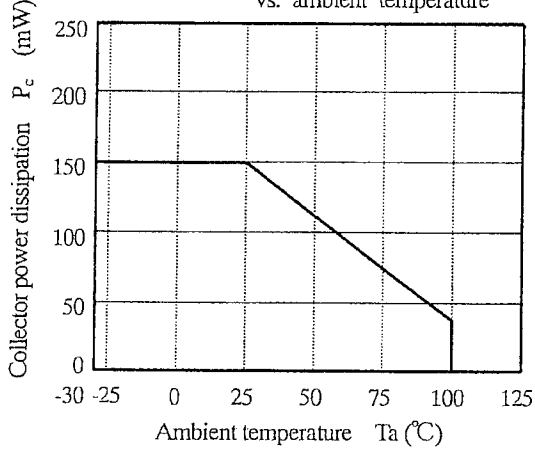
(Fig. 1) Forward current vs. ambient temperature



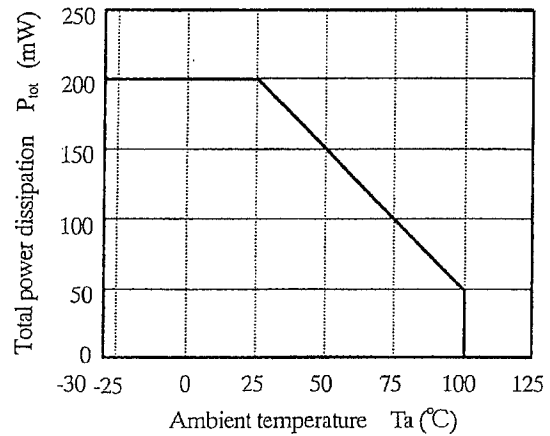
(Fig. 2) Diode power dissipation vs. ambient temperature



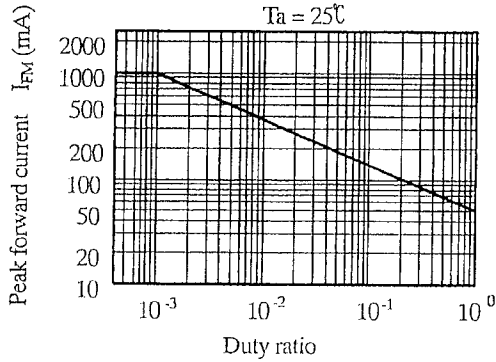
(Fig. 3) Collector power dissipation vs. ambient temperature



(Fig. 4) Total power dissipation vs. ambient temperature



(Fig. 5) Peak forward current vs. duty ratio
Pulse width $\leq 100 \mu s$
 $T_a = 25^\circ C$



REFERENCE

4. Reliability

The reliability of products shall satisfy items listed below.

Confidence level : 90%

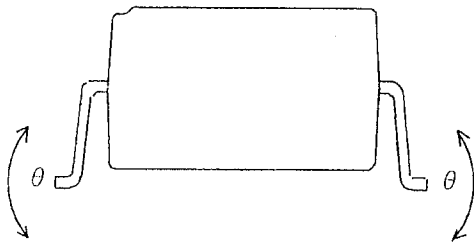
LTPD : 10 or 20

Test Items	Condition #1	Failure Judgment Criteria	Samples (n) Defective (C)	
Solderability	245±3°C, 5s	*2	n=11, C=0	
Soldering heat	(Flow soldering) 270°C, 10 s	$V_F > U \times 1.2$ $I_R > U \times 2$ $I_{CEO} > U \times 2$ $I_C < L \times 0.7$ $V_{CE(sat)} > U \times 1.2$	n=11, C=0	
	(Soldering by hand) 400°C, 3 s			
Terminal strength (Tension)	Weight: 5N 5 s/each terminal		n=11, C=0	
Terminal strength Bending) *3	Weight: 2.5N 2 times/each terminal		n=11, C=0	
Mechanical shock	15km/s ² , 0.5ms 3 times/±X, ±Y, ±Z direction		n=11, C=0	
Variable frequency vibration	100 to 2000 to 100Hz/4 min 200m/s ² 4 times/X, Y, Z direction		U: Upper specification limit	n=11, C=0
Temperature cycling	1 cycle -55°C to +125°C (30 min) (30 min) 20 cycles test		L: Lower specification limit	n=22, C=0
High temp. and high Humidity storage	+85°C, 85%RH, 1000h		n=22, C=0	
High temp. storage	+125°C, 1000h		n=22, C=0	
Low temp. storage	-55°C, 1000h		n=22, C=0	
Operation life	I _F =50mA, P _{tot} =200mW T _a =25°C, 1000h		n=22, C=0	

*1 Test method, conforms to BIAJ ED 4701.

*2 The product whose not-soldered area is more than 5% for all of the dipped area and/or whose pinholes or voids are concentrated on one place shall be judged defect.

*3 Terminal bending direction is shown below.





5. Outgoing inspection

5.1 Inspection items

(1) Electrical characteristics

$V_F, I_R, I_{CEO}, V_{CE(sat)}, I_c, R_{ISO}, V_{iso}$

(2) Appearance

5.2 Sampling method and Inspection level

A single sampling plan, normal inspection level II based on ISO 2859 is applied.

The AQL according to the inspection items are shown below.

Defect	Inspection item	AQL(%)
Major defect	Electrical characteristics Unreadable marking	0.065
Minor defect	Appearance defect except the above mentioned.	0.25

6.2 Package specifications

6.2.1 Taping conditions

- (1) Tape structure and Dimensions (Refer to the attached sheet, Page 9)
 - The carrier tape has the heat pressed structure of PS material carries tape and three layers cover tape (PET material base).
- (2) Reel structure and Dimensions (Refer to the attached sheet, Page 10)
 - The taping reel shall be of plastic (PS material).
- (3) Direction of product insertion (Refer to the attached sheet, Page 10)
- (4) Joint of tape
The cover tape and carrier tape in one reel shall be joint less.
- (5) To repair failure-taped devices, cutting a bottom of carrier tape with a cutter.
After replacing the cut portion shall be sealed with adhesive tape.

6.2.2 Adhesiveness of cover tape

- The exfoliation force between carrier tape and cover tape shall be 0.2N to 0.7N for the angle 160° to 180° .

6.2.3 Rolling method and quantity

- Wind the tape back on the reel so that the cover tape will be outside the tape.
- Attach more than 20cm of blank tape to the trailer and the leader of the and fix the both ends with adhesive tape.
One reel basically shall contain 2000pcs.

6.2.4 Outer packing appearance

- Refer to the attached sheet, page 10.

6.2.5 Marking

The label with following information shall be pasted at appointed place of the outer packing case.

- * Model No. *(Business dealing name) * Lot No. * Quantity
- * Country of origin *Company name *Inspection date specified

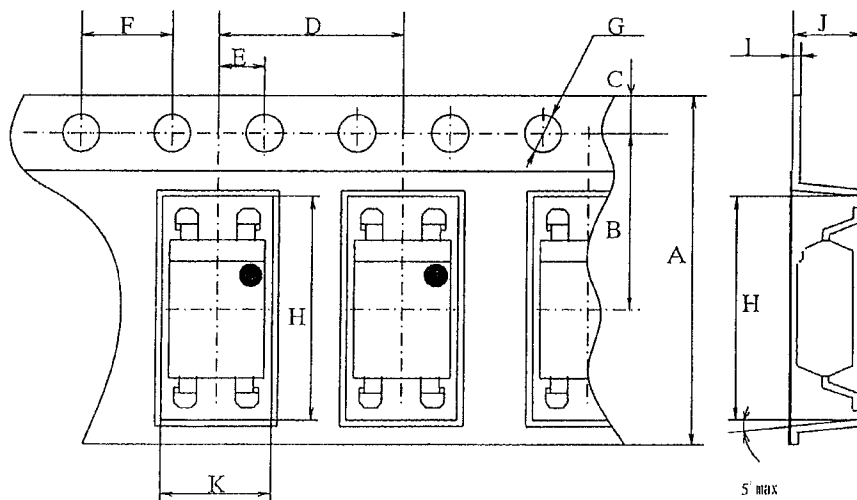
6.2.6 Storage condition

- Taped products shall be stored at the temperature 5 to 30°C and the humidity 70%RH or less away from direct sunlight.

6.2.7 Safety protection during shipping

- There shall be no deformation of component or degradation of electrical characteristics due to shipping.

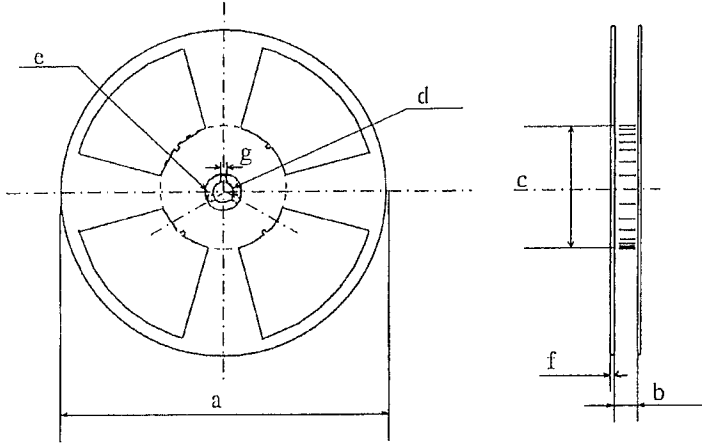
Carrier tape structure and Dimensions



Dimensions list (Unit : mm)

A	B	C	D	E	F	G	H	I	J	K
±0.3	±0.1	±0.10	±0.1	±0.1	±0.1	+0.1 -0.0	±0.1	±0.05	±0.1	±0.1
16.0	7.5	1.75	8.0	2.0	4.0	φ1.5	10.4	0.40	4.2	5.1

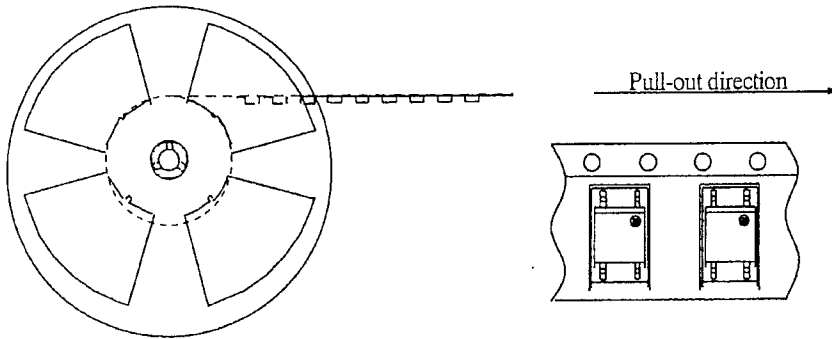
Reel structure and Dimensions



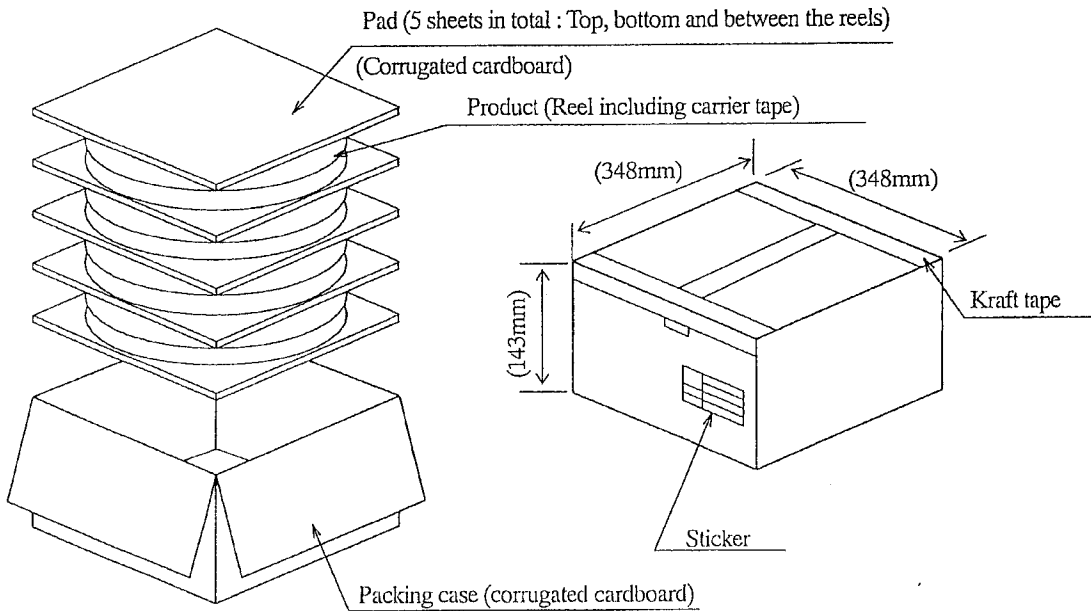
Dimensions list (Unit : mm)

a	b	c	d
(330)	17.5±1.5	φ100.0±1.0	φ13.0±0.5
e	f	g	
φ23.0±1.0	2.0±0.5	2.0±0.5	

Direction of product insertion

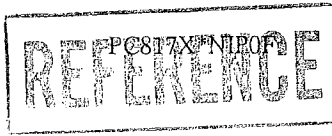


Outer packing appearance



Regular packing mass : Approx. 4.1kg

() : Reference dimensions



Precautions for Photocouplers

1. Cleaning

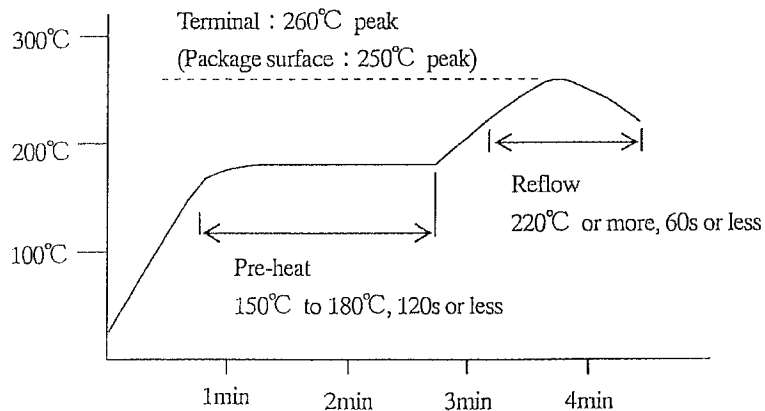
- (1) Solvent cleaning : Solvent temperature 45°C or less
Immersion for 3 min or less
- (2) Ultrasonic cleaning : The effect to device by ultrasonic cleaning differs by cleaning bath size, ultrasonic power output, cleaning time, PCB size or device mounting condition etc. Please test it in actual using condition and confirm that any defect doesn't occur before starting the ultrasonic cleaning.
- (3) Applicable solvent : Ethyl alcohol, Methyl alcohol, Isopropyl alcohol
When the other solvent is used, there are cases that the packaging resin is eroded.
Please use the other solvent after thorough confirmation is performed in actual using condition.

2. Circuit design

- (1) The LED used in the Photocoupler generally decreases the light emission power by operation.
In case of long operation time, please design the circuit in consideration of the degradation of the light emission power of the LED. (50%/5years)
- (2) There are cases that the deviation of the CTR and the degradation of the relative light emission power of the LED increase when the setting value of I_F is less than 1.0mA. Please design the circuit in consideration of this point.

3. Precautions for Soldering

- (1) In the case of flow soldering (Whole device dipping .)
It is recommended that flow soldering should be at 270°C or less for 10 s or less
(Pre-heating : 100 to 150°C, 30 to 80s). (2 times or less)
- (2) If solder reflow :
It is recommended to be done at the temperature and the time within the temperature profile as shown in the figure below. (2 times or less)



- (3) In the case of hand soldering
What is done on the following condition is recommended. (2 times or less)
Soldering iron temperature : 400°C or less
Time : 3s or less
- (4) Other precautions
Depending on equipment and soldering conditions (temperature, Using solder etc.), the effect to the device and the PCB is different.
Please confirm that there is no problem on the actual use conditions in advance.

Opto Specification

Opto/EC Group



NORTH AMERICA

Sharp Microelectronics of the Americas
5700 NW Pacific Rim Blvd.
Camas, WA 98607, U.S.A.
Phone: (1) 360-834-2500
Fax: (1) 360-834-8903
www.sharpsma.com

TAIWAN

Sharp Electronic Components
(Taiwan) Corporation
8F-A, No. 16, Sec. 4, Nanking E. Rd.
Taipei, Taiwan, Republic of China
Phone: (886) 2-2577-7341
Fax: (886) 2-2577-7326/2-2577-7328

CHINA

Sharp Microelectronics of China
(Shanghai) Co., Ltd.
28 Xin Jin Qiao Road King Tower 16F
Pudong Shanghai, 201206 P.R. China
Phone: (86) 21-5854-7710/21-5834-6056
Fax: (86) 21-5854-4340/21-5834-6057
Head Office:
No. 360, Bashen Road,
Xin Development Bldg. 22
Waigaoqiao Free Trade Zone Shanghai
200131 P.R. China
Email: smc@china.global.sharp.co.jp

EUROPE

Sharp Microelectronics Europe
Division of Sharp Electronics (Europe) GmbH
Sonninstrasse 3
20097 Hamburg, Germany
Phone: (49) 40-2376-2286
Fax: (49) 40-2376-2232
www.sharpsme.com

SINGAPORE

Sharp Electronics (Singapore) PTE., Ltd.
438A, Alexandra Road, #05-01/02
Alexandra Technopark,
Singapore 119967
Phone: (65) 271-3566
Fax: (65) 271-3855

KOREA

Sharp Electronic Components
(Korea) Corporation
RM 501 Geosung B/D, 541
Dohwa-dong, Mapo-ku
Seoul 121-701, Korea
Phone: (82) 2-711-5813 ~ 8
Fax: (82) 2-711-5819

JAPAN

Sharp Corporation
Electronic Components & Devices
22-22 Nagaïke-cho, Abeno-Ku
Osaka 545-8522, Japan
Phone: (81) 6-6621-1221
Fax: (81) 6117-725300/6117-725301
www.sharp-world.com

HONG KONG

Sharp-Roxy (Hong Kong) Ltd.
Level 26, Tower 1, Kowloon Commerce Centre,
No. 51, Kwai Cheong Road, Kwai Chung,
New Territories, Hong Kong
Phone: (852) 28229311
Fax: (852) 28660779
www.sharp.com.hk
Shenzhen Representative Office:
Room 602-603, 6/F,
International Chamber of Commerce Tower,
168 Fuhua Rd. 3, CBD,
Futian District, Shenzhen 518048,
Guangdong, P.R. China
Phone: (86) 755-88313505
Fax: (86) 755-88313515

SPECIFICATIONS ARE SUBJECT TO CHANGE WITHOUT NOTICE.

Suggested applications (if any) are for standard use; See Important Restrictions for limitations on special applications. See Limited Warranty for SHARP's product warranty.

The Limited Warranty is in lieu, and exclusive of, all other warranties, express or implied.

ALL EXPRESS AND IMPLIED WARRANTIES, INCLUDING THE WARRANTIES OF MERCHANTABILITY, FITNESS FOR USE AND FITNESS FOR A PARTICULAR PURPOSE, ARE SPECIFICALLY EXCLUDED. In no event will SHARP be liable, or responsible in any way, for any incidental or consequential economic or property damage.